

# MBR0540

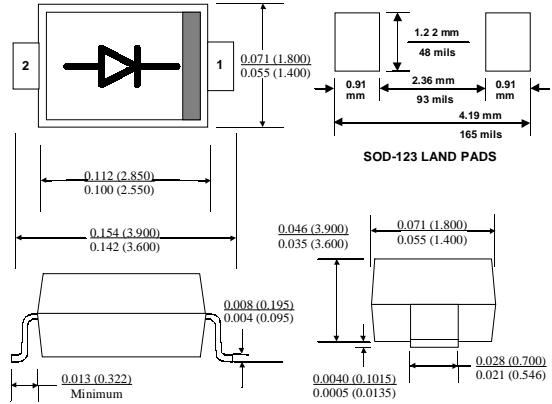
## Features

- 1.0 Ampere; forward voltage less than 620 mV.
- 400 milliwatt Power Dissipation package.
- Compact surface mount with same footprint as mini-melf.



**SOD123**  
Mark: B4

**Actual Size**



## Ordering:

- 7 inch reel (178 mm); 8 mm Tape; 3,000 units per reel.

## 1.0 Ampere Schottky Power Rectifiers

### Absolute Maximum Ratings\* $T_A = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Value	Units
$I_O$	Average Rectified Current	500	mA
$I_{f(surge)}$	Peak Forward Surge Current half wave, single phase, 60 Hz Superimposed on rated load (JEDEC method)	5.5	A
$V_{RRM}$	Peak Repetitive Reverse Voltage	40	V
$V_{RWM}$	Working Peak Reverse Voltage	40	V
$V_R$	DC Blocking Voltage	40	V
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient **	206	$^\circ\text{C}/\text{W}$
$R_{\theta JL}$	Thermal Resistance, Junction to Lead ***	118	$^\circ\text{C}/\text{W}$
$T_{stg}$	Storage Temperature Range	-65 to +150	$^\circ\text{C}$
$T_J$	Operating Junction Temperature	-65 to +125	$^\circ\text{C}$

\*These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

\*\*1.0 inch\* pad size (1.0 x 0.5 inch for each lead) on FR4 board.

\*\*\*Device mounted on FR-4 PCB 0.013 mm.

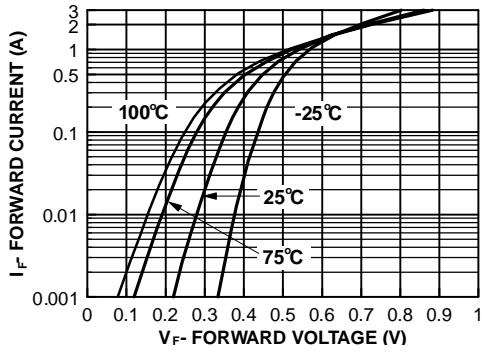
### Electrical Characteristics $T_A = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Min	Max	Units	
$I_R$	Reverse Leakage		$V_R = 20\text{ V}, T_A = 25^\circ\text{C}$	10	$\mu\text{A}$
			$V_R = 20\text{ V}, T_A = 100^\circ\text{C}$	5.0	mA
			$V_R = 40\text{ V}, T_A = 25^\circ\text{C}$	20	$\mu\text{A}$
			$V_R = 40\text{ V}, T_A = 100^\circ\text{C}$	13	mA
$V_F$	Forward Voltage (Note 1)		$I_F = 500\text{ mA}, T_A = 25^\circ\text{C}$	510	mV
			$I_F = 500\text{ mA}, T_A = 100^\circ\text{C}$	460	mV
			$I_F = 1.0\text{ A}, T_A = 25^\circ\text{C}$	620	mV
			$I_F = 1.0\text{ A}, T_A = 100^\circ\text{C}$	610	mV

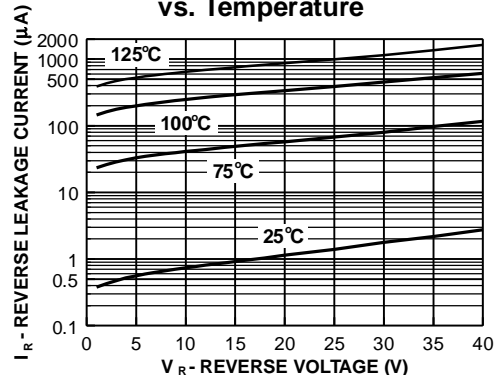
**Note:** Pulse Test: Pulse Width  $\leq 250\mu\text{s}$ , Duty Cycle  $\leq 2.0\%$

Typical Characteristics

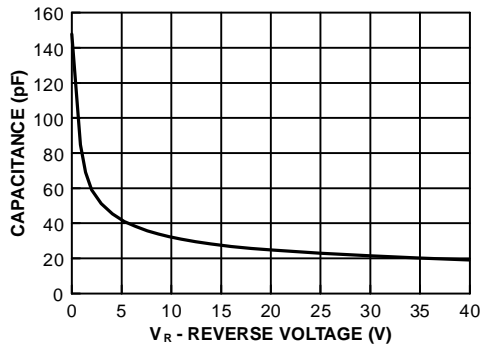
Forward Voltage  
vs. Temperature



Reverse Leakage Current  
vs. Temperature



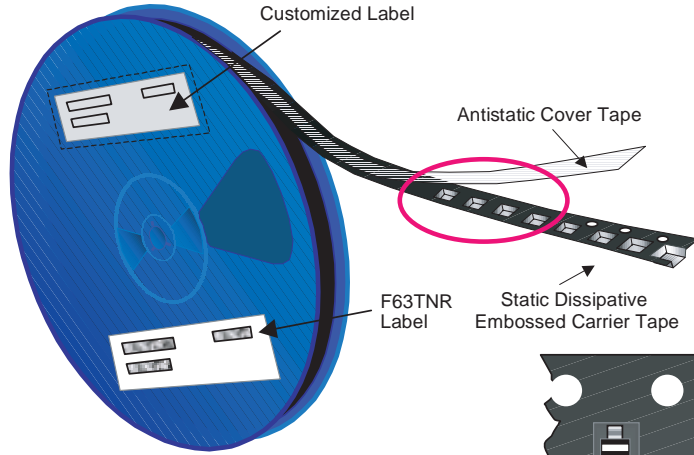
Capacitance  
vs. Reverse Voltage



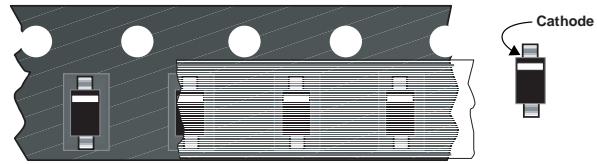
# SOD-123 Tape and Reel Data and Package Dimensions



## SOD123 Packaging Configuration: Figure 1.0

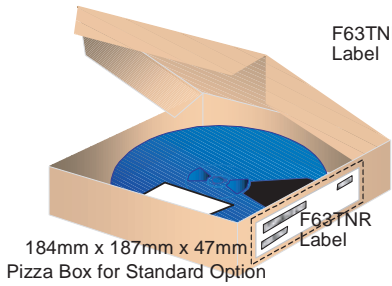
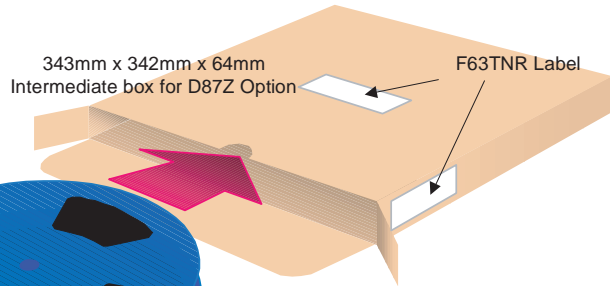


**Packaging Description:**  
 SOD123 parts are shipped in tape. The carrier tape is made from a dissipative (carbon filled) polycarbonate resin. The cover tape is a multilayer film (Heat Activated Adhesive in nature) primarily composed of polyester film, adhesive layer, sealant, and anti-static sprayed agent. These reeled parts in standard option are shipped with 3,000 units per 7" or 177cm diameter reel. The reels are dark blue in color and is made of polystyrene plastic (anti-static coated). Other option comes in 10,000 units per 13" or 330cm diameter reel. This and some other options are described in the Packaging Information table.  
 These full reels are individually barcode labeled and placed inside a pizza box (illustrated in figure 1.0) made of recyclable corrugated brown paper with a Fairchild logo printing. One pizza box contains three reels maximum. And these pizza boxes are placed inside a barcode labeled shipping box which comes in different sizes depending on the number of parts shipped.



SOD123 Unit Orientation

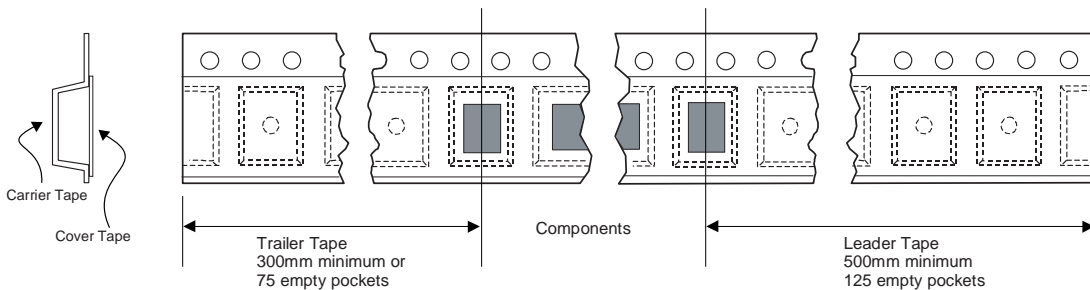
SOD123 Packaging Information			
Packaging Option	Standard (no flow code)	L99Z	D87Z
Packaging type	TNR	TNR	TNR
Qty per Reel/Tube/Bag	3,000	3,000	10,000
Reel Size	7" Dia	7" Dia	13"
Box Dimension (mm)	184x187x47	184x187x47	343x343x64
Max qty per Box	9,000	9,000	30,000
Weight per unit (gm)	0.01	0.01	0.01
Weight per Reel (kg)	0.123	0.123	0.420
Note/Comments		No marking required	



F63TNR Label sample

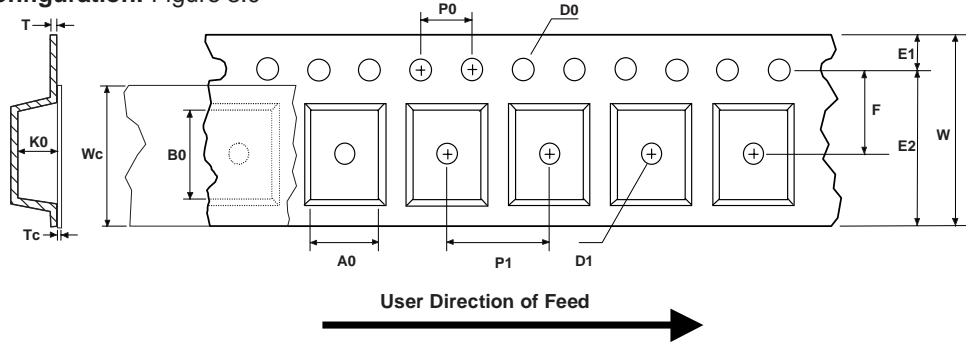


## SOD123 Tape Leader and Trailer Configuration: Figure 2.0



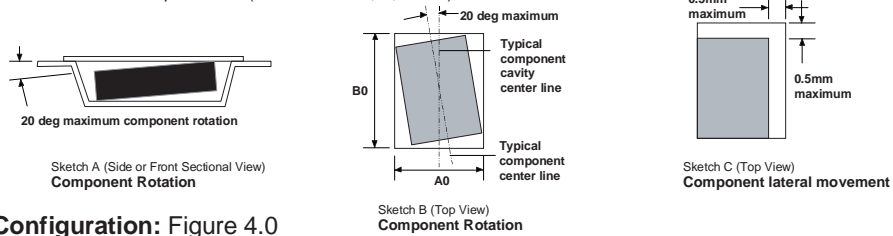
# SOD-123 Tape and Reel Data and Package Dimensions, continued

## SOD123 Embossed Carrier Tape Configuration: Figure 3.0

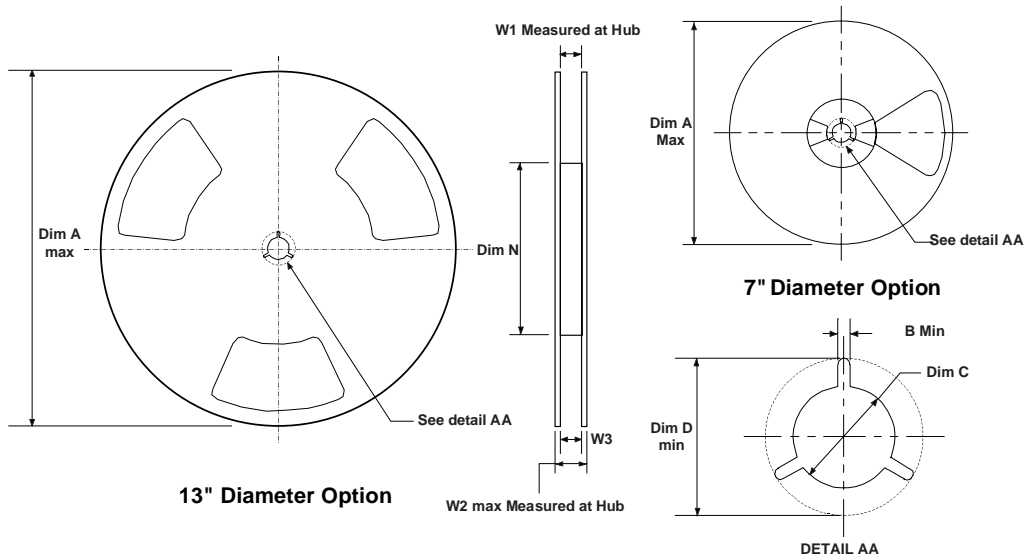


Dimensions are in millimeter														
Pkg type	A0	B0	W	D0	D1	E1	E2	F	P1	P0	K0	T	Wc	Tc
SOD123 (8mm)	1.85 ±0.10	3.94 ±0.10	8.0 ±0.3	1.50 ±0.10	1.125 ±0.125	1.75 ±0.10	6.25 min	3.50 ±0.05	4.0 ±0.1	4.0 ±0.1	1.50 ±0.10	0.200 ±0.020	5.2 ±0.2	0.06 ±0.02

Notes: A0, B0, and K0 dimensions are determined with respect to the EIA/Jedec RS-481 rotational and lateral movement requirements (see sketches A, B, and C).



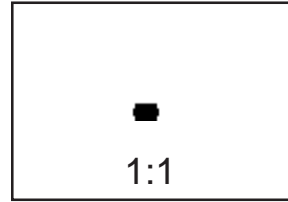
## SOD123 Reel Configuration: Figure 4.0



Dimensions are in inches and millimeters									
Tape Size	Reel Option	Dim A	Dim B	Dim C	Dim D	Dim N	Dim W1	Dim W2	Dim W3 (LSL-USL)
8mm	7" Dia	7.00 177.8	0.059 1.5	512 +0.020/-0.008 13 +0.5/-0.2	0.795 20.2	2.165 55	0.331 +0.059/-0.000 8.4 +1.5/0	0.567 14.4	0.311 - 0.429 7.9 - 10.9
8mm	13" Dia	13.00 330	0.059 1.5	512 +0.020/-0.008 13 +0.5/-0.2	0.795 20.2	4.00 100	0.331 +0.059/-0.000 8.4 +1.5/0	0.567 14.4	0.311 - 0.429 7.9 - 10.9

SOD-123 Tape and Reel Data and Package Dimensions, continued

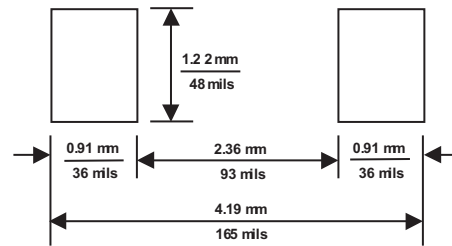
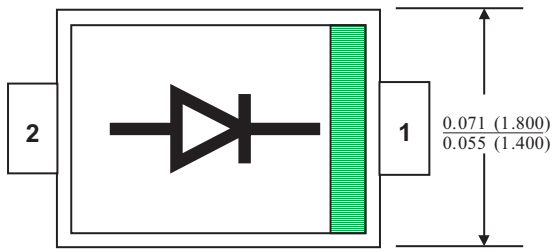
SOD-123 (FS PKG Code D6)



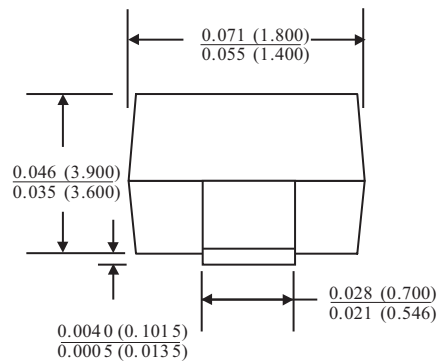
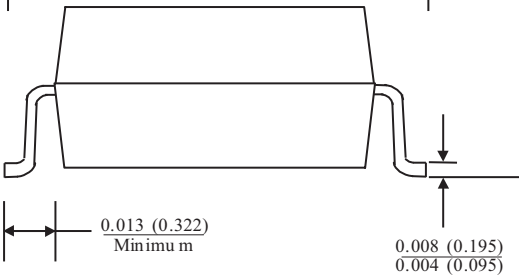
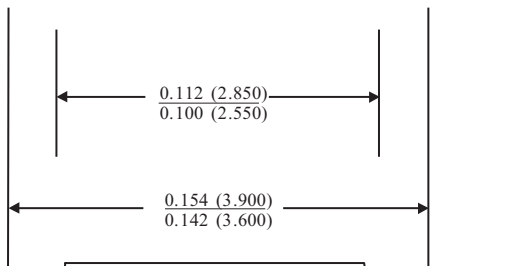
Scale 1:1 on letter size paper

Dimensions shown below are in:  
inches [millimeters]

Part Weight per unit (gram): 0.01



SOD-123 LAND PADS



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